# **Special Issue**

# Advances in Hardware-Software Codesign

### Message from the Guest Editors

The aim of this Special Issue is to focus on hardware–software codesign advanced methods for signal, video, or image processing to give a large view of this complex field by covering topics that include but are not limited to the following areas:

- Embedded systems;
- Hardware architectures for signal and image processing: manycore processors, FPGAs, DSPs, GPUs, SoCs;
- Advances in algorithm-architecture mapping;
- Hardware-software synthesis, computer-aided tools (compilers, hardware synthesis);
- Reconfigurable systems;
- Real time processing;
- Vision systems;
- Smart sensors;
- Sensor data fusion;
- Systems for robotics and automation;
- Embedded artificial intelligence;
- Applications to simultaneous localization and mapping (SLAM), autonomous vehicles, UAVs, medical, biomedical, smart agriculture, smart cities.

### **Guest Editors**

Dr. Abdelhafid El Ouardi

Dr. Sergio Rodriguez

Dr. Bastien Vincke

### Deadline for manuscript submissions

closed (31 October 2023)



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## **About the Journal**

### Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

### Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and Telecommunications, Politecnico di Torino, 10129 Torino, Italy

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